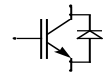


# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## FD 600 R 17 KF6 B2

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**vorläufige Daten**  
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### Höchstzulässige Werte / Maximum rated values

#### Elektrische Eigenschaften / Electrical properties

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	1700	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$	$I_{C,nom.}$	600	A
	$T_C = 25^\circ\text{C}$	$I_C$	1200	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$	$I_{CRM}$	1200	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ\text{C}$ , Transistor	$P_{tot}$	4,8	kW
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V
Dauergleichstrom DC forward current		$I_F$	600	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	1200	A
Grenzlastintegral der Diode $I^2t$ - value, Diode	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^\circ\text{C}$	$I^2t$	110	$\text{kA}^2\text{s}$
Isolations-Prüfspannung insulation test voltage	RMS, $f = 50\text{ Hz}, t = 1\text{ min.}$	$V_{ISOL}$	4	kV

### Charakteristische Werte / Characteristic values

#### Transistor / Transistor

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$I_C = 600\text{A}, V_{GE} = 15\text{V}, T_{vj} = 25^\circ\text{C}$	$V_{CE\text{ sat}}$	-	2,7	3,2	V
	$I_C = 600\text{A}, V_{GE} = 15\text{V}, T_{vj} = 125^\circ\text{C}$		-	3,2		V
Gate-Schwellenspannung gate threshold voltage	$I_C = 40\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	$V_{GE(th)}$	4,5	5,5	6,5	V
Gateladung gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$	$Q_G$	-	7,2	-	$\mu\text{C}$
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$	$C_{ies}$	-	40	-	nF
Rückwirkungskapazität reverse transfer capacitance	$f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$	$C_{res}$	-	t.b.d.	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{CE} = 1700\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^\circ\text{C}$	$I_{CES}$	-	0,2	1,2	mA
	$V_{CE} = 1700\text{V}, V_{GE} = 0\text{V}, T_{vj} = 125^\circ\text{C}$		-	20		mA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^\circ\text{C}$	$I_{GES}$	-	-	400	nA

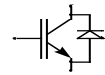
prepared by: Oliver Schilling	date of publication: 12.11.1998
approved by: M. Hierholzer	revision: 1

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### Charakteristische Werte / Characteristic values

#### Transistor / Transistor

			min.	typ.	max.	
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = 600A, V_{CE} = 900V$	$t_{d,on}$	-	0,3	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$					
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 600A, V_{CE} = 900V$	$t_r$	-	0,17	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$					
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = 600A, V_{CE} = 900V$	$t_{d,off}$	-	1,1	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$					
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 600A, V_{CE} = 900V$	$t_f$	-	0,11	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 2,4\Omega, T_{vj} = 125^\circ C$					
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = 600A, V_{CE} = 900V, V_{GE} = 15V$	$E_{on}$	-	270	-	mWs
	$R_G = 2,4\Omega, T_{vj} = 125^\circ C, L_S = 50nH$					
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = 600A, V_{CE} = 900V, V_{GE} = 15V$	$E_{off}$	-	220	-	mWs
	$R_G = 2,4\Omega, T_{vj} = 125^\circ C, L_S = 50nH$					
Kurzschlußverhalten SC Data	$t_p \leq 10\mu sec, V_{GE} \leq 15V$	$I_{SC}$	-	2400	-	A
	$T_{vj} \leq 125^\circ C, V_{CC} = 1000V, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$					
Modulinduktivität stray inductance module		$L_{sCE}$	-	20	-	nH
Modulleitungswiderstand, Anschlüsse - Chip module lead resistance, terminals - chip	pro Zweig / per arm	$R_{CC+EE}$	-	0,16	-	m $\Omega$

### Charakteristische Werte / Characteristic values

#### Diode / Diode

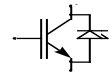
			min.	typ.	max.	
Durchlaßspannung forward voltage	$I_F = 600A, V_{GE} = 0V, T_{vj} = 25^\circ C$	$V_F$	-	2,2	2,6	V
	$I_F = 600A, V_{GE} = 0V, T_{vj} = 125^\circ C$					
Rückstromspitze peak reverse recovery current	$I_F = 600A, -di_F/dt = 4200A/\mu sec$	$I_{RM}$	-	360	-	A
	$V_R = 900V, V_{GE} = -10V, T_{vj} = 25^\circ C$					
	$V_R = 900V, V_{GE} = -10V, T_{vj} = 125^\circ C$					
Sperrverzögerungsladung recovered charge	$I_F = 600A, -di_F/dt = 4200A/\mu sec$	$Q_r$	-	80	-	$\mu As$
	$V_R = 900V, V_{GE} = -10V, T_{vj} = 25^\circ C$					
	$V_R = 900V, V_{GE} = -10V, T_{vj} = 125^\circ C$					
Abschaltenergie pro Puls reverse recovery energy	$I_F = 600A, -di_F/dt = 4200A/\mu sec$	$E_{rec}$	-	40	-	mWs
	$V_R = 900V, V_{GE} = -10V, T_{vj} = 25^\circ C$					
	$V_R = 900V, V_{GE} = -10V, T_{vj} = 125^\circ C$					

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**vorläufige Daten**  
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### Thermische Eigenschaften / Thermal properties

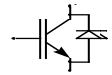
			min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to case	Transistor / transistor, DC	$R_{thJC}$	-	-	0,026	K/W
	Diode/Diode, DC		-	-	0,05	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module $\lambda_{Paste} = 1 \text{ W/m}^2\text{K}$ / $\lambda_{grease} = 1 \text{ W/m}^2\text{K}$	$R_{thCK}$	-	0,016		K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{op}$	-40	-	125	°C
Lagertemperatur storage temperature		$T_{stg}$	-40	-	125	°C

### Mechanische Eigenschaften / Mechanical properties

Gehäuse, siehe Anlage case, see appendix					
Innere Isolation internal insulation				AlN	
Kriechstrecke creepage distance				15	mm
Luftstrecke clearance				10	mm
CTI comperative tracking index				275	
Anzugsdrehmoment f. mech. Befestigung mounting torque		M1		5	Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque		M2	terminals M4	2	Nm
			terminals M8	8 - 10	Nm
Gewicht weight		G		1050	g

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert.  
Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

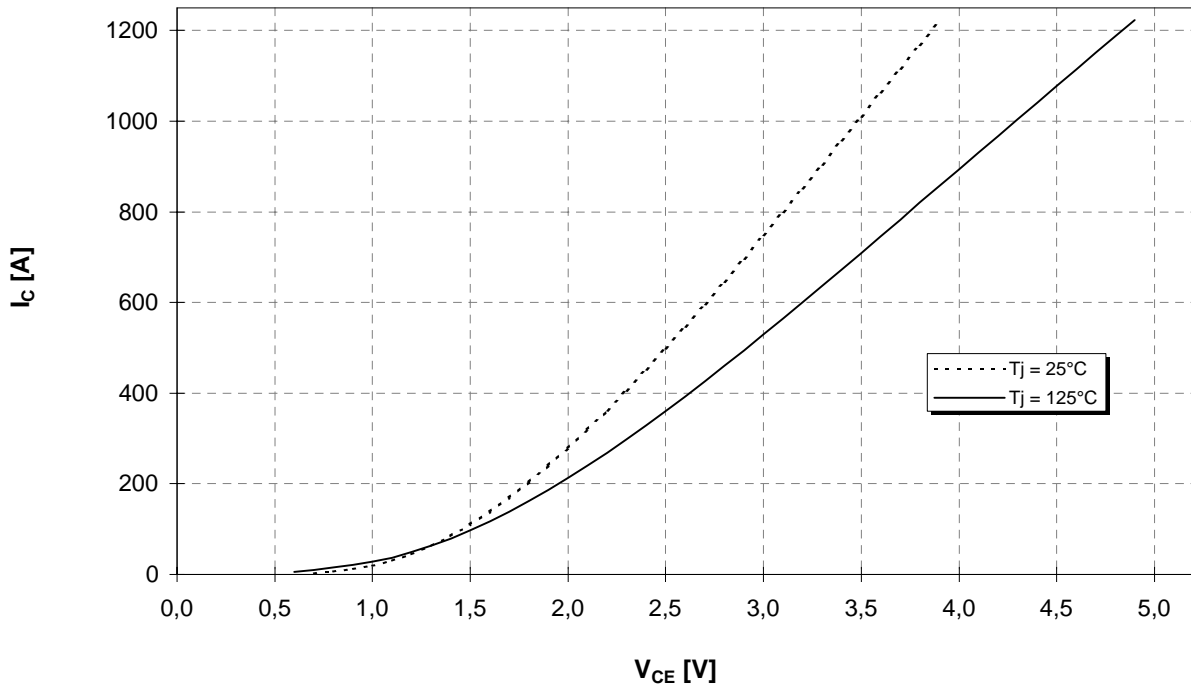
This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.



Ausgangskennlinie (typisch)  
Output characteristic (typical)

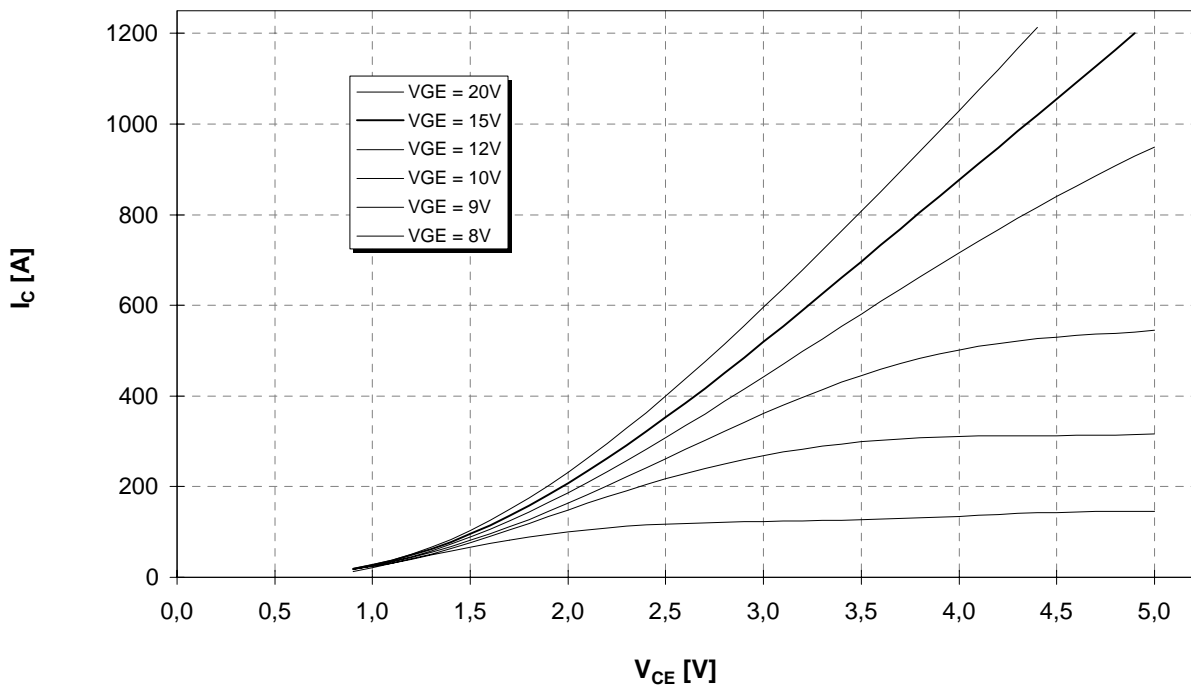
$I_c = f(V_{CE})$   
 $V_{GE} = 15V$

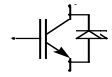
vorläufige Daten  
preliminary data



Ausgangskennlinienfeld (typisch)  
Output characteristic (typical)

$I_c = f(V_{CE})$   
 $T_{vj} = 125°C$

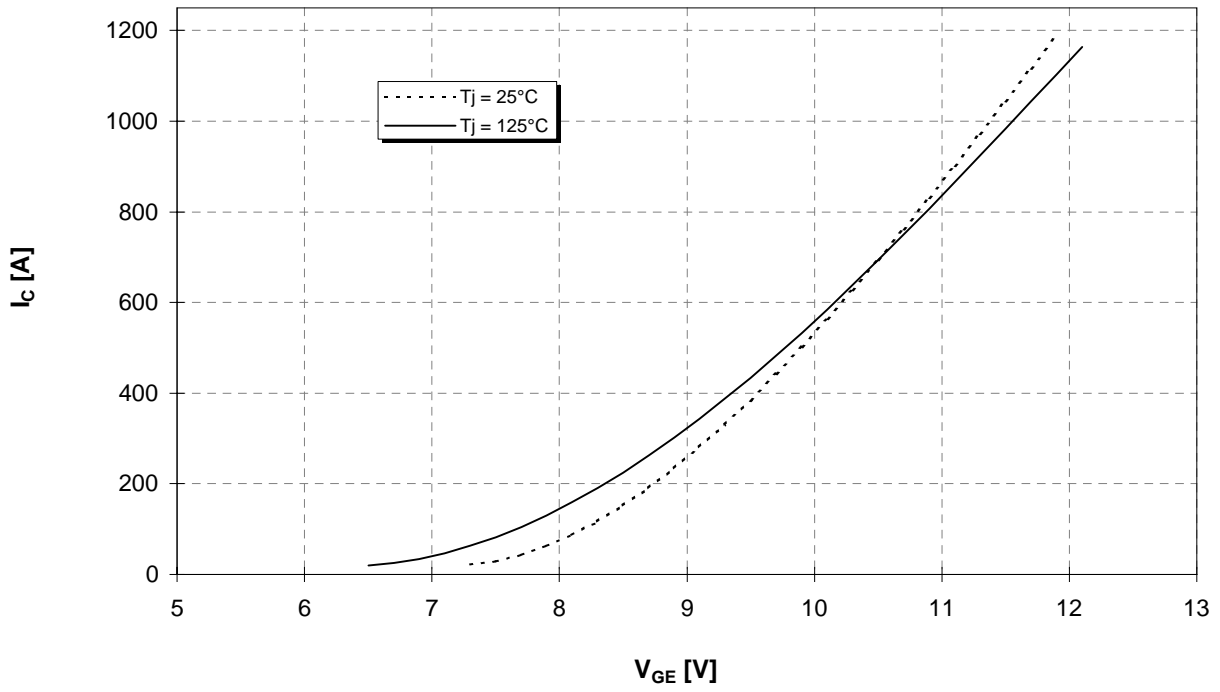




vorläufige Daten  
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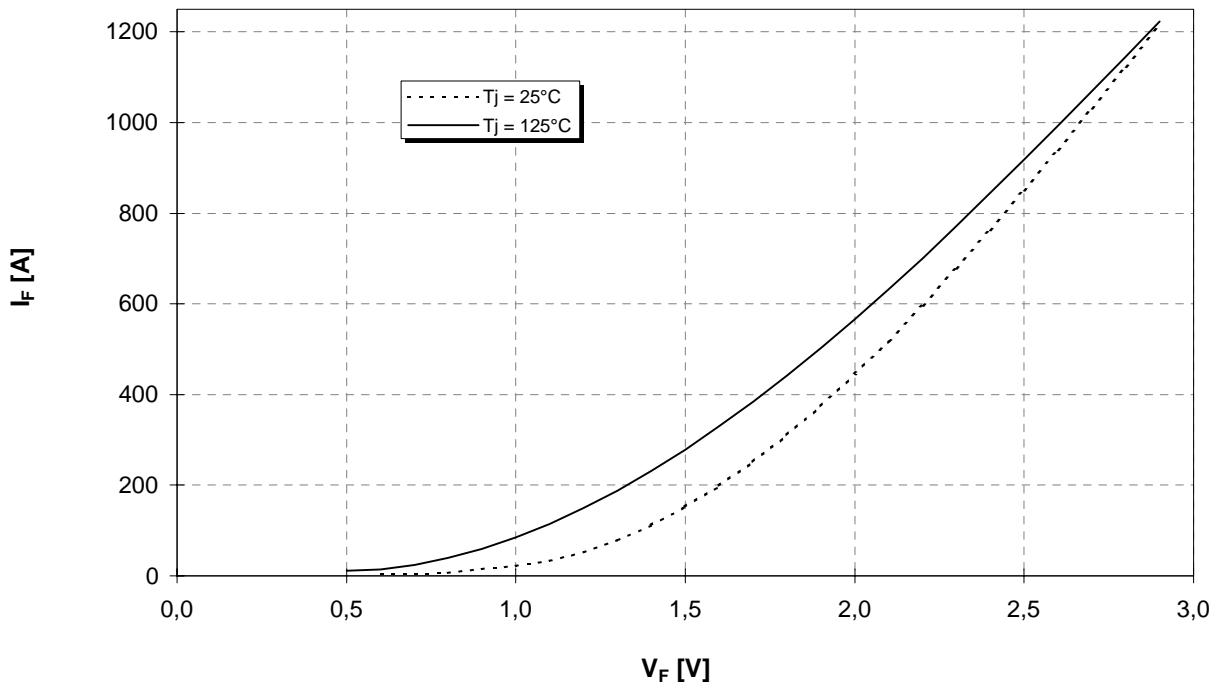
Übertragungscharakteristik (typisch)  
Transfer characteristic (typical)

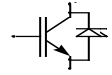
$I_c = f(V_{GE})$   
 $V_{CE} = 20V$



Durchlaßkennlinie der Inversdiode (typisch)  
Forward characteristic of inverse diode (typical)

$I_F = f(V_F)$

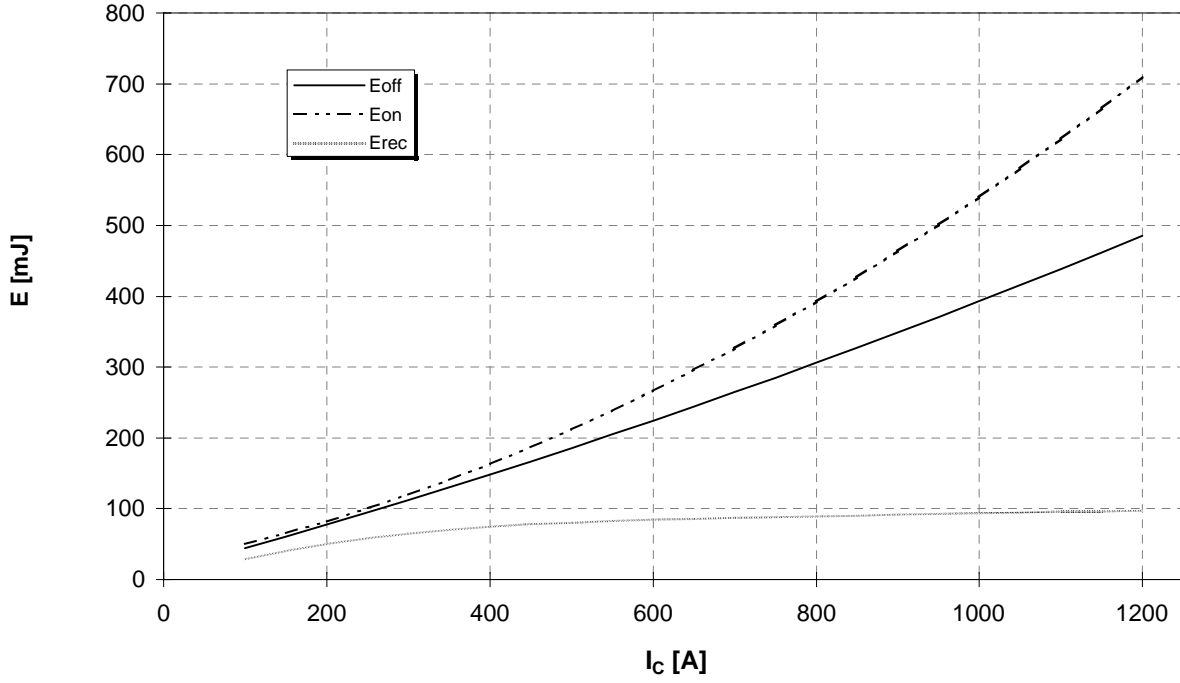




vorläufige Daten  
preliminary data

Schaltverluste (typisch)  $E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$ ,  $E_{rec} = f(I_C)$

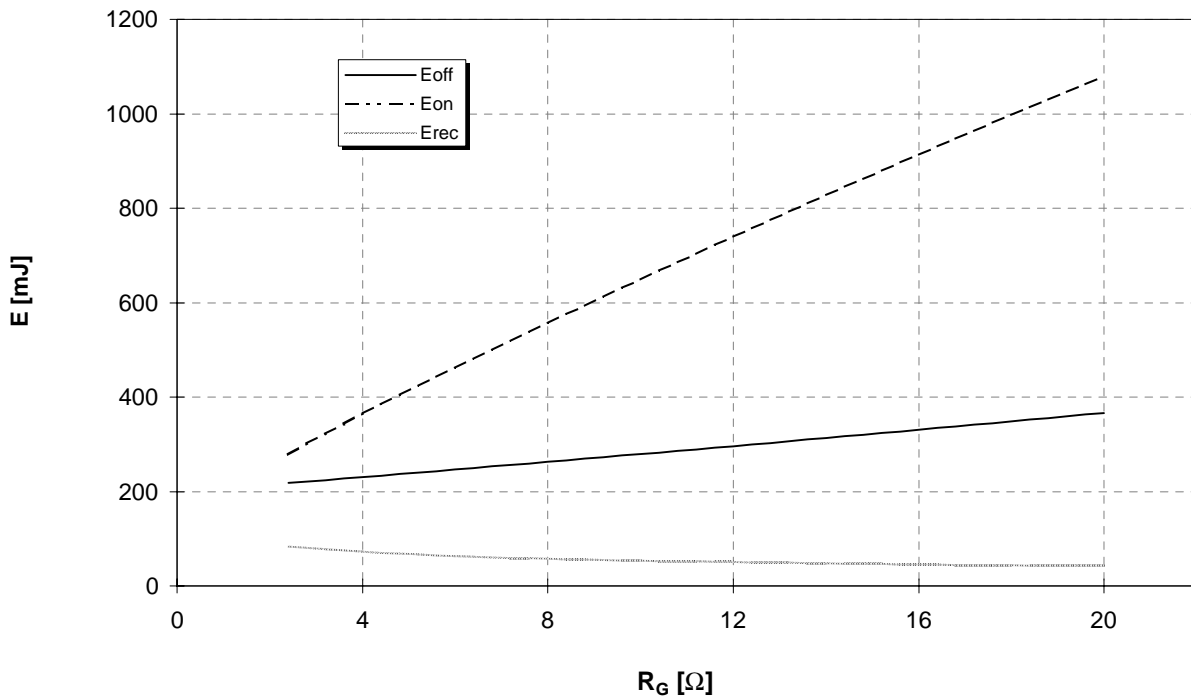
Switching losses (typical)  $R_{gon} = R_{goff} = 2,4 \Omega$ ,  $V_{CE} = 900V$ ,  $T_J = 125^\circ C$ ,  $V_{GE} = \pm 15V$

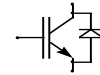


Schaltverluste (typisch)  
Switching losses (typical)

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$ ,  $E_{rec} = f(R_G)$

$I_C = 600A$ ,  $V_{CE} = 900V$ ,  $T_J = 125^\circ C$ ,  $V_{GE} = \pm 15V$



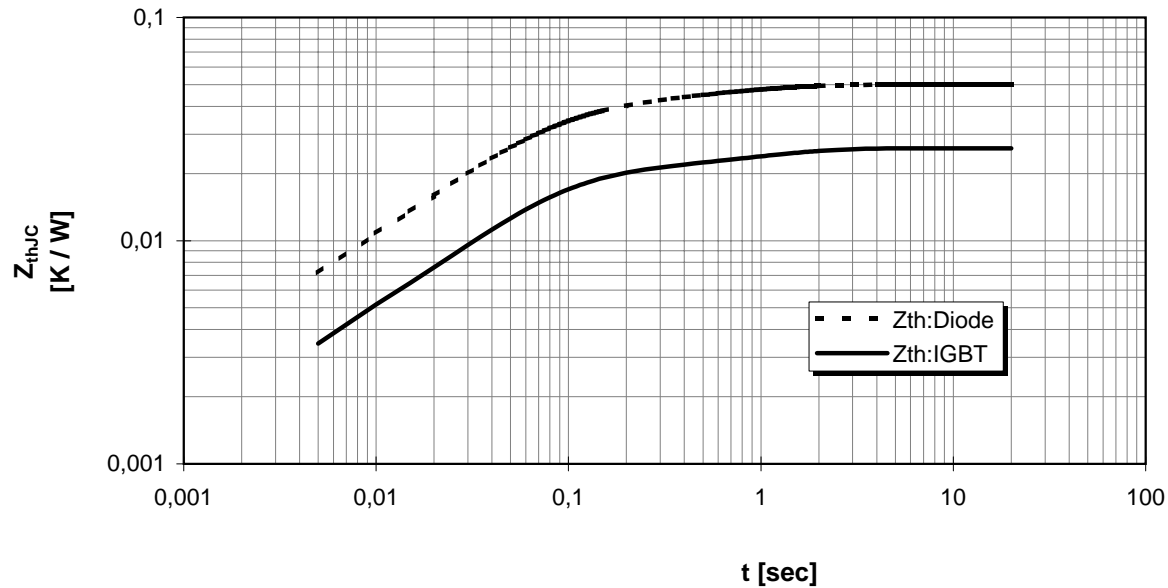


vorläufige Daten

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Transienter Wärmewiderstand  
Transient thermal impedance

$$Z_{thJC} = f(t)$$

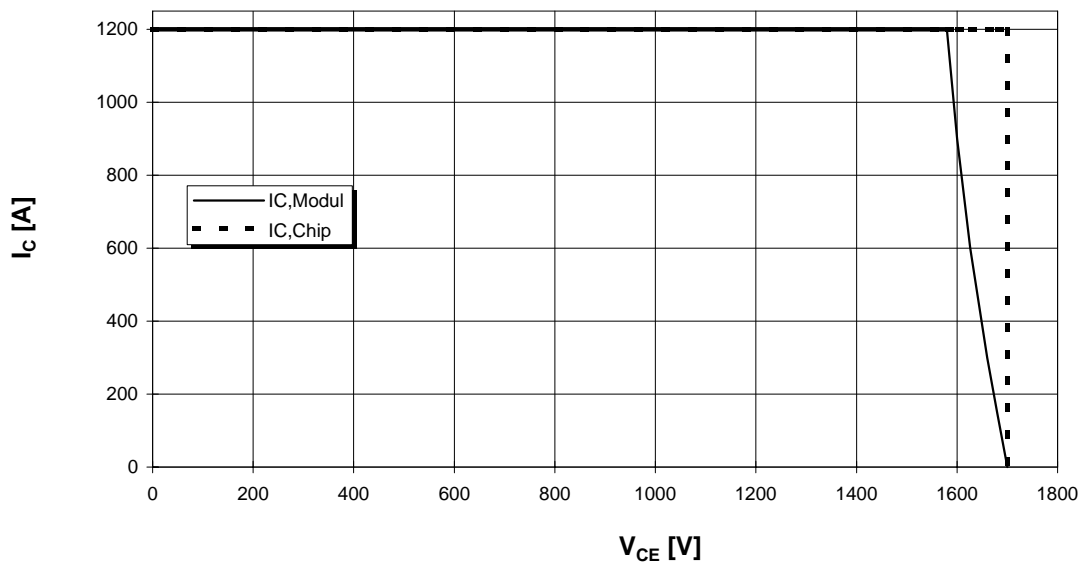


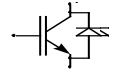
i	1	2	3	4
$r_i$ [K/kW] : IGBT	2,5	12,3	5,2	6
$\tau_i$ [sec] : IGBT	0,003	0,05	0,1	0,95
$r_i$ [K/kW] : Diode	4,92	26,8	9,14	9,14
$\tau_i$ [sec] : Diode	0,003	0,045	0,45	0,75

Sicherer Arbeitsbereich (RBSOA)

Reverse bias safe operation area (RBSOA)

$R_q = 2,4 \text{ Ohm}$ ,  $T_v = 125^\circ\text{C}$





Äußere Abmessungen / external dimensions

